CMOS Digital Integrated Circuits Silicon Monolithic

TC7USB3212WBG

1. Functional Description

• Quad SPDT USB Switch

2. General

The TC7USB3212WBG is a 2 differential channel, 1-2 multiplexer/demultiplexer for USB3.0 (5Gbps), or other high-speed interface applications.

This device consists of four individual multiplexer/demultiplexer with common select input (SEL) and output enable (\overline{OE}) . The An+/An- inputs is connected to the Bn+/Bn- or Cn+/Cn- outputs determined by the combination both the select input (SEL) and output enable (\overline{OE}) . When the output enable (\overline{OE}) input is held high level, the switches are open with regardless the state of select inputs and a high-impedance state exists between the switches.

All inputs are equipped with protection circuits against static discharge.

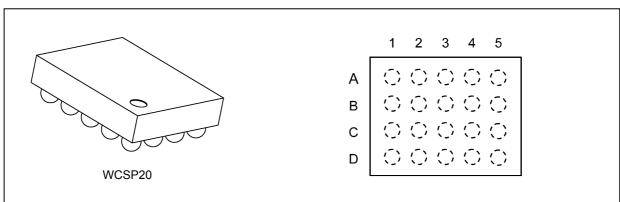
3. Features

- (1) Supply voltage: $V_{CC} = 1.65$ to 1.95 V
- (2) ON-resistance: $R_{ON} = 4.5 \Omega$ (typ.) @V_{CC} = 1.65 V, V_{IS} = 0 V
- (3) -3dB Bandwidth: BW = 8 GHz (typ.) @V_{CC} = 1.8 V
- (4) Insertion Loss: IL = -1 dB (typ.) $@V_{CC} = 1.8 V$, f = 2.5 GHz,
- (5) Power-down protection provided on all inputs and outputs.
- (6) Package: WCSP20

Note: Handling Precaution

When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

4. Packaging and Pin Assignment (Top View)

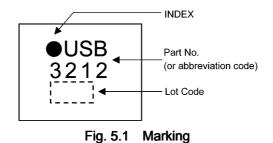


4.1. Pin Assignment

	1	2	3	4	5
А	A0+	B0+	B0-	B1+	B1-
В	A0-	GND	GND	GND	V _{CC}
С	A1+	GND	GND	ŌĒ	SEL
D	A1-	C0+	C0-	C1+	C1-

Start of commercial production 2014-07 2015-11-10

5. Marking



6. System Diagram

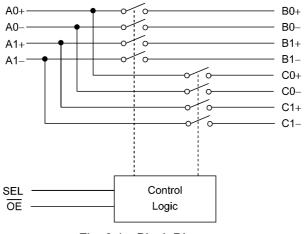


Fig. 6.1 Block Diagram

7. Principle of Operation

7.1. Truth Table

Input OE	Input SEL	Function
L	L	An+ port = Bn+ port, An- Port = Bn- Port
L	Н	An+ port = Cn+ port, An- Port = Cn- Port
Н	Х	Disconnect

X: Don't Care

8. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Test Condition Rating		Unit
Supply voltage	V _{CC}		—	-0.5 to 2.5	V
Input voltage (OE, SEL)	V _{IN}			-0.5 to 2.5	
Switch I/O voltage	Vs		V _{CC} = 0 V or Switch OFF	-0.5 to 2.5	
			Switch ON	-0.5 to V _{CC} +0.5	
Switch I/O current	ا _S		—	45	mA
Power dissipation	PD			210	mW
V _{CC} /ground current	I _{CC} /I _{GND}			±50	mA
Storage temperature	T _{stg}			-55 to 125	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

9. Operating Ranges (Note)

Characteristics	Symbol	Note	Test Condition	Rating	Unit
Supply voltage	V _{CC}		—	1.65 to 1.95	V
Input voltage (OE, SEL)	V _{IN}			0 to 1.95	
Switch I/O voltage	Vs		V _{CC} = 0 V or Switch OFF	-0.35 to 1.95	
			Switch ON	-0.35 to V_{CC}	
Operating temperature	T _{opr}		—	-40 to 85	°C
Input rise time	dt/dv			0 to 10	ns/V
Input fall time				0 to 10	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either V_{CC} or GND.

10. Electrical Characteristics

10.1. DC Characteristics (Note) (Unless otherwise specified, $T_a = -40$ to 85°C)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Min	Тур.	Max	Unit
High-level input voltage (OE, SEL)	V _{IH}		_	1.65 to 1.95	$0.75 \times V_{CC}$	—	—	V
Low-level input voltage (\overline{OE} , SEL)	V _{IL}			1.65 to 1.95		—	$0.35 \times V_{CC}$	
Input leakage current (OE, SEL)	I _{IN}		V _{IN} = 0 to 1.95 V	1.65 to 1.95	_	—	±5	μA
Power-OFF leakage current	I _{OFF}		V _{IN} = V _{IS} = 0 to 1.95 V	0	_	—	±20	
Switch OFF-state leakage current	I _{SZ}		$V_{IS} = 0$ to V_{CC} , $\overline{OE} = GND$	1.65 to 1.95	_	—	±5	
ON-resistance	R _{ON}	(Note 1)	V _{IS} = 0 V, I _{IS} = 30 mA	1.65	-	4.5	6	Ω
			V _{IS} = 0.5 V, I _{IS} = 30 mA	1.65		4.7	6.4	
			V _{IS} = 1.65 V, I _{IS} = 30 mA	1.65		7.5	13	
Difference of ON-resistance between switches	ΔR_{ON}	(Note 1)	V_{IS} = 0.5 V, I_{IS} = 30 mA (bit to bit)	1.65		0.1	—	
ON-resistance flatness	R _{ON(flat)}	(Note 1)	$V_{IS} = 0 V \text{ to } 1.0 V,$ $I_{IS} = 30 \text{ mA}$	1.65		1.0	—	
Quiescent supply current	I _{CC}		$\frac{V_{IN}}{OE} = V_{CC} \text{ or GND}$	1.95	—	—	25	μA
			$\frac{V_{IN}}{OE} = V_{CC} \text{ or GND}$		_	_	200	

Note: All typical values are at $T_a = 25^{\circ}C$.

Note 1: Measured by the voltage drop between An+/An- and Bn+/Bn-,Cn+/Cn- pins at the indicated current through the switch. On-resistance is determined by the lower of the voltages on the two pins.

10.2. AC Characteristics (Note) (Unless otherwise specified, $T_a = -40$ to 85°C)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Min	Тур.	Max	Unit
Propagation delay time	t _{PLH} /t _{PHL}	(Note 1)	C _L = 5 pF, See Fig. 11.1	1.8 ± 0.15	_	0.1	—	ns
Turn-ON time (SEL, OE to output)	t _{on}		R _L = 50 Ω, C _L = 5 pF, See Fig. 11.2		_	0.5	1	μs
Turn-OFF time (SEL, OE to output)	t _{off}				_	0.1	0.5	
Break before make	ТВВМ		R _L = 50 Ω, C _L = 5 pF, See Fig. 11.3		200		700	ns
Output skew (bit to bit)	t _{SK(b)}	(Note 1)	C _L = 5 pF, See Fig. 11.4		_	1.5	_	ps
Output skew (channel to channel)	t _{SK(CH)}	(Note 1)	$C_L = 5 \text{ pF}$, See Fig. 11.5			9.5		

Note: All typical values are at $T_a = 25^{\circ}C$.

Note 1: Parameter guaranteed by design.

10.3. Analog Switch (Note) (Unless otherwise specified, $T_a = -40$ to 85°C)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	Min	Тур.	Max	Unit
OFF isolation (non-adjacent)	OIRR		R _T = 50 Ω, f = 2.5 GHz, See Fig. 11.6	1.8 ± 0.15	—	-30	_	dB
Crosstalk (non-adjacent)	Xtalk		R _T = 50 Ω, f = 2.5 GHz, See Fig. 11.7		_	-25	_	
Insertion loss	IL		R _T = 50 Ω, f = 2.5 GHz, See Fig. 11.8		_	-1	_	
-3dB Bandwidth	BW		R _T = 50 Ω, C _L = 0 pF, See Fig. 11.8			8		GHz

Note: All typical values are at $T_a = 25^{\circ}$ C. Parameter guaranteed by design.

11. AC Test Circuits and Waveforms

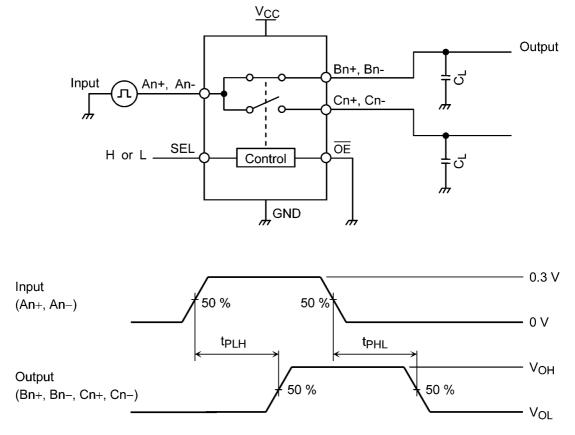


Fig. 11.1 Propagation Delay Time (t_{PLH}, t_{PHL})

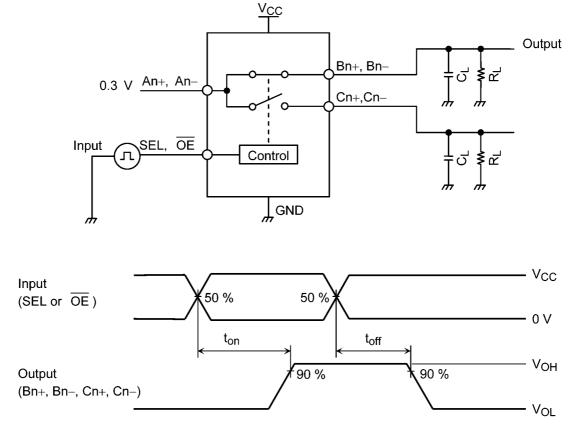


Fig. 11.2 Turn-ON and Turn-OFF Times (ton, toff)

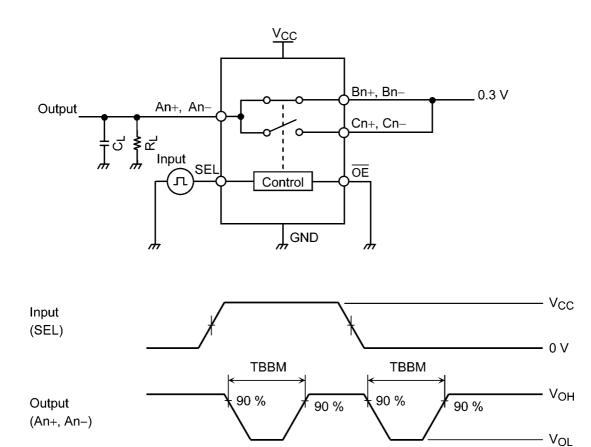
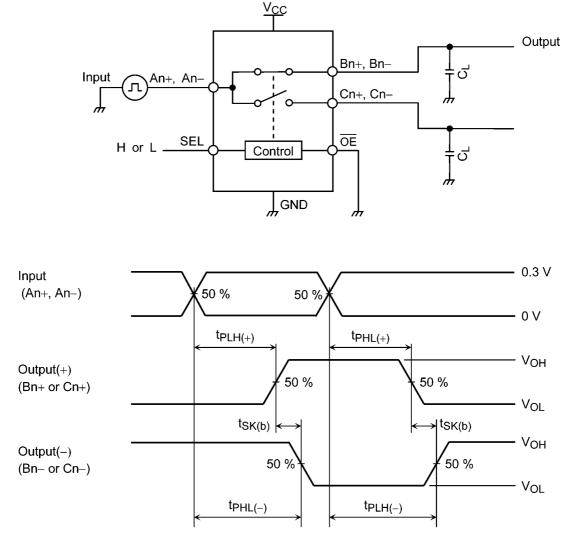
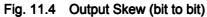
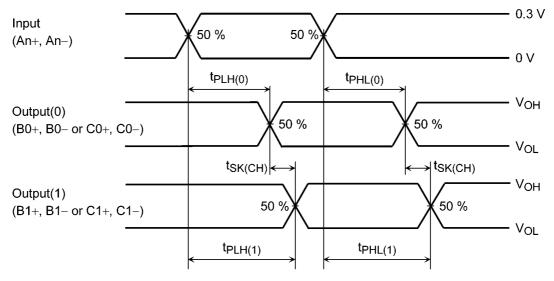


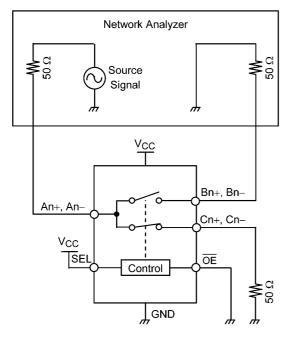
Fig. 11.3 Break Before Make (TBBM)





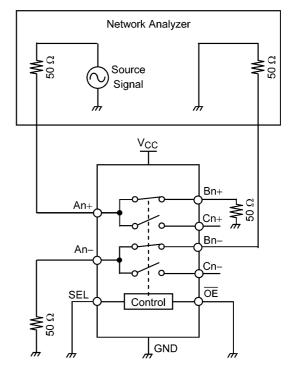






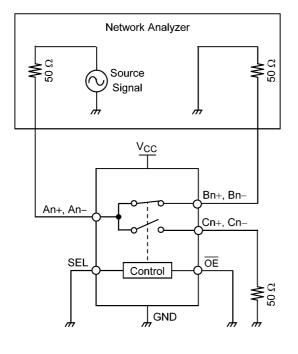
All unused ports are connected to GND through 50 Ω pull-down resistors.

Fig. 11.6 OFF Isolation



All unused ports are connected to GND through 50 Ω pull-down resistors.

Fig. 11.7 Crosstalk



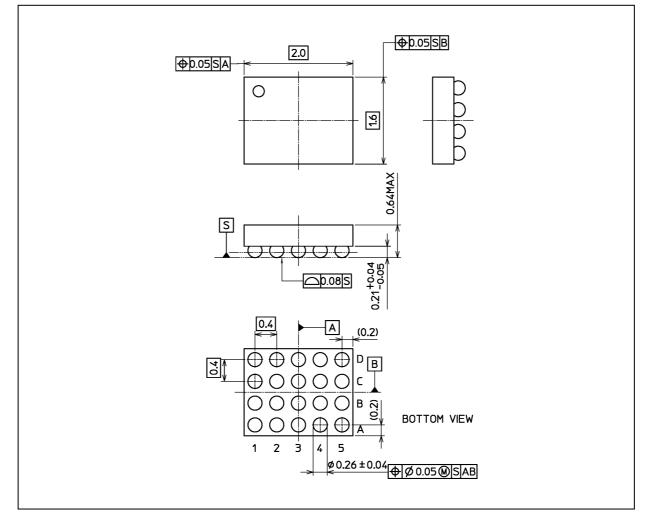
All unused ports are connected to GND through 50 Ω pull-down resistors.



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Package Dimensions

Unit: mm



This resins used in this product include no flame retardants.

Weight: 0.005 g (typ.)

Package Name(s)
TOSHIBA: S-UFBGA20-0202-0.40-001
Nickname: WCSP20

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